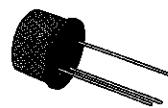


HIGH-SPEED SATURATED SWITCH

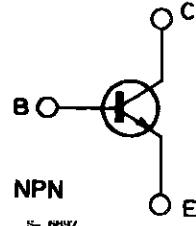
DESCRIPTION

The BSX28 is a silicon planar epitaxial NPN transistor in Jedec TO-18 metal case. It is designed specifically for high speed saturated switching applications.



TO-18

INTERNAL SCHEMATIC DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{CBO}	Collector-base Voltage ($I_E = 0$)	30	V
V_{CES}	Collector-emitter Voltage ($V_{BE} = 0$)	30	V
V_{CEO}	Collector-emitter Voltage ($I_B = 0$)	12	V
V_{EBO}	Emitter-base Voltage ($I_C = 0$)	4.5	V
I_C	Collector Current	500	mA
P_{tot}	Total Power Dissipation at $T_{amb} \leq 25^\circ\text{C}$ at $T_{case} \leq 25^\circ\text{C}$ at $T_{case} \leq 100^\circ\text{C}$	0.36 1.2 0.68	W
T_{stg}, T_j	Storage and Junction Temperature	- 65 to 200	°C

BSX28

THERMAL DATA

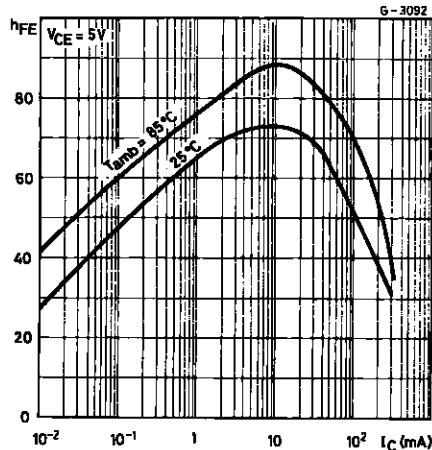
$R_{th\ j\text{-case}}$	Thermal Resistance Junction-case	Max	146	$^{\circ}\text{C/W}$
$R_{th\ j\text{-amb}}$	Thermal Resistance Junction-ambient	Max	486	$^{\circ}\text{C/W}$

ELECTRICAL CHARACTERISTICS ($T_{amb} = 25^{\circ}\text{C}$ unless otherwise specified)

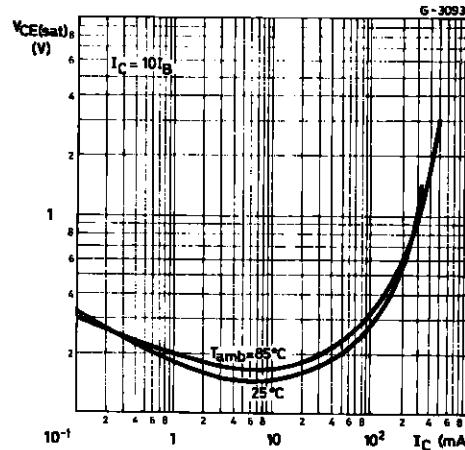
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
I_{CES}	Collector Cutoff Current ($V_{BE} = 0$)	$V_{CE} = 20\text{ V}$ $V_{CE} = 20\text{ V}$ $T_{amb} = 85^{\circ}\text{C}$			0.4 10	μA μA
$V_{(BR)CBO}$	Collector-base Breakdown Voltage ($I_E = 0$)	$I_C = 10\text{ }\mu\text{A}$	30			V
$V_{(BR)CES}$	Collector-emitter Breakdown Voltage ($V_{BE} = 0$)	$I_C = 10\text{ }\mu\text{A}$	30			V
$V_{(BR)CEO}^*$	Collector-emitter Breakdown Voltage ($I_B = 0$)	$I_C = 10\text{ mA}$	12			V
$V_{(BR)EBO}$	Emitter-base Breakdown Voltage ($I_C = 0$)	$I_E = 100\text{ }\mu\text{A}$	4.5			V
$V_{CE(sat)}^*$	Collector-emitter Saturation Voltage	$I_C = 10\text{ mA}$ $I_B = 1\text{ mA}$ $I_C = 30\text{ mA}$ $I_B = 3\text{ mA}$ $I_C = 100\text{ mA}$ $I_B = 10\text{ mA}$ $I_C = 10\text{ mA}$ $I_B = 1\text{ mA}$ $T_{amb} = 85^{\circ}\text{C}$		0.15 0.18 0.3 0.17	0.2 0.25 0.5 0.3	V V V V
$V_{BE(sat)}^*$	Base-emitter Saturation Voltage	$I_C = 10\text{ mA}$ $I_B = 1\text{ mA}$ $I_C = 30\text{ mA}$ $I_B = 3\text{ mA}$ $I_C = 100\text{ mA}$ $I_B = 10\text{ mA}$	0.72	0.8 0.9 1.1	0.87 1.15 1.6	V V V
h_{FE}^*	DC Current Gain	$I_C = 10\text{ mA}$ $V_{CE} = 0.35\text{ V}$ $I_C = 30\text{ mA}$ $V_{CE} = 0.4\text{ V}$ $I_C = 100\text{ mA}$ $V_{CE} = 1\text{ V}$	30 25 15	70 70 50	120	
f_T	Transition Frequency	$I_C = 20\text{ mA}$ $V_{CE} = 10\text{ V}$ $f = 100\text{ MHz}$	400	650		MHz
C_{CBO}	Collector-base Capacitance	$I_E = 0$ $V_{CB} = 5\text{ V}$ $f = 1\text{ MHz}$			2.3 4	pF
t_s	Storage Time	$I_C = 10\text{ mA}$ $V_{CC} = 10\text{ V}$ $I_{B1} = -I_{B2} = 10\text{ mA}$			6.5 13	ns
t_{on}	Turn-on Time	$I_C = 30\text{ mA}$ $V_{CC} = 2\text{ V}$ $I_{B1} = 3\text{ mA}$			9 15	ns
t_{off}	Turn-off Time	$I_C = 30\text{ mA}$ $V_{CC} = 2\text{ V}$ $I_{B1} - I_{B2} = 3\text{ mA}$			13 20	ns

* Pulsed : pulse duration = 300 ms, duty cycle = 1 %.

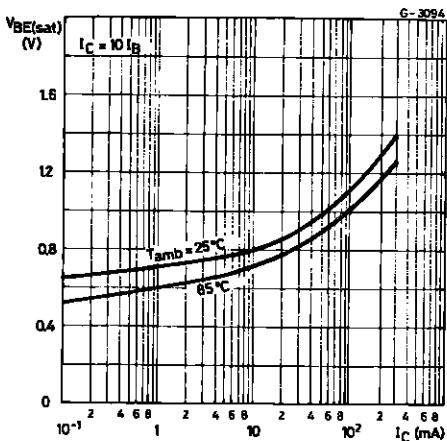
DC Current Gain.



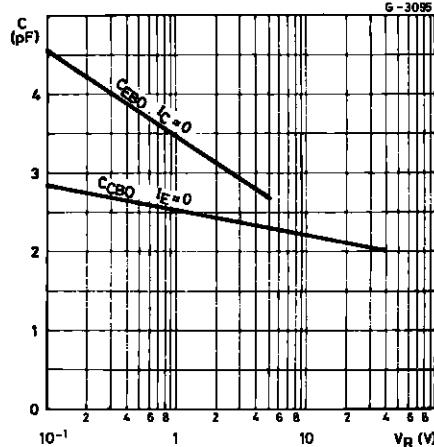
Collector-emitter Saturation Voltage.



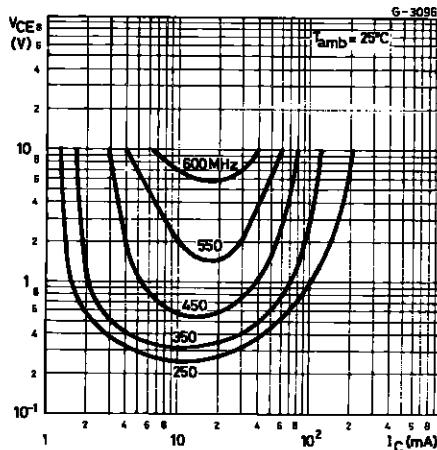
Base-emitter Saturation Voltage.



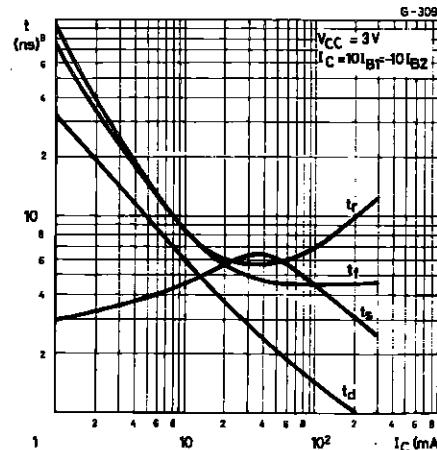
Emitter-base and Collector-base Capacitances.



Contours of Constant Transition Frequency.

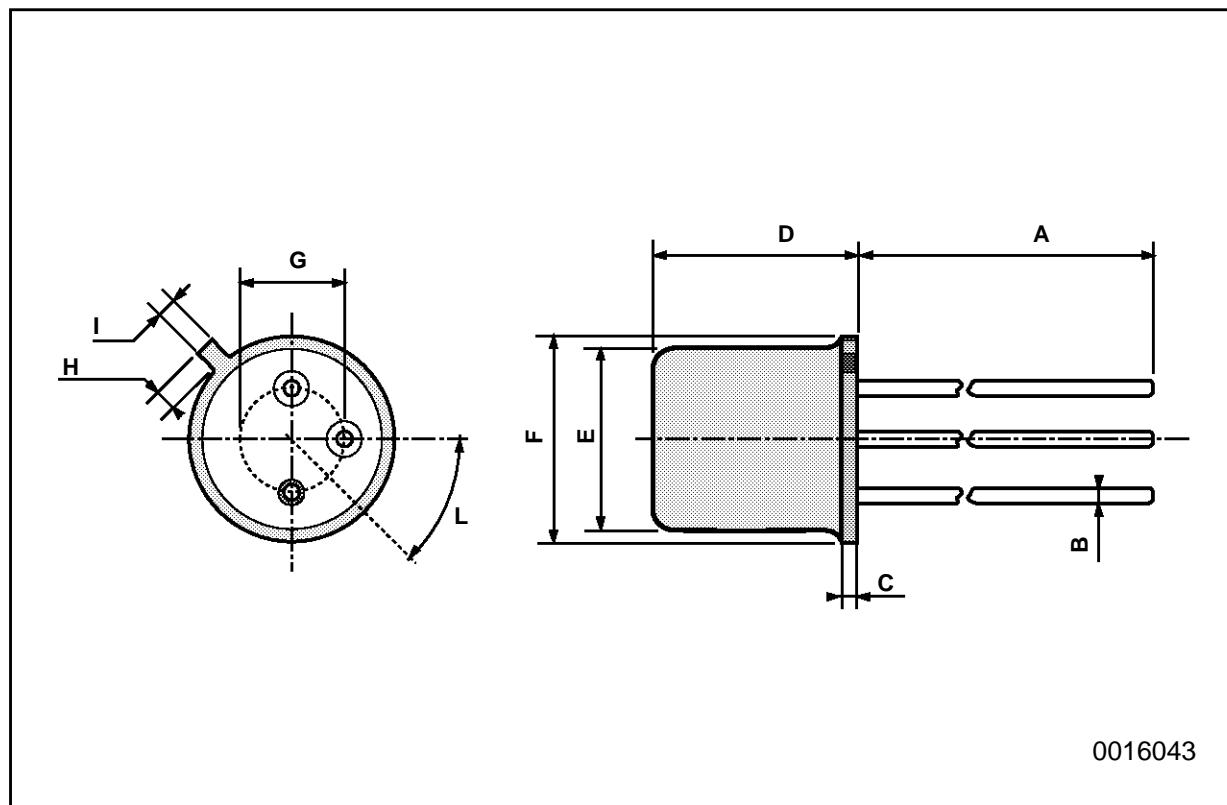


Switching Characteristics.



TO-18 MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A		12.7			0.500	
B			0.49			0.019
D			5.3			0.208
E			4.9			0.193
F			5.8			0.228
G	2.54			0.100		
H			1.2			0.047
I			1.16			0.045
L	45°			45°		



Information furnished is believed to be accurate and reliable. However, SGS-THOMSON Microelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of SGS-THOMSON Microelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. SGS-THOMSON Microelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of SGS-THOMSON Microelectronics.

© 1994 SGS-THOMSON Microelectronics - All Rights Reserved

SGS-THOMSON Microelectronics GROUP OF COMPANIES
Australia - Brazil - France - Germany - Hong Kong - Italy - Japan - Korea - Malaysia - Malta - Morocco - The Netherlands -
Singapore - Spain - Sweden - Switzerland - Taiwan - Thailand - United Kingdom - U.S.A